

**Application No.: 09/897,416****Docket No.: 30010519-1 US (1509-194)****Amendments to the Specification:**

**Please replace paragraph on page 25, lines 15-18 with the following amended paragraph:**

It will be noted that the fractal pattern 88 has a general path direction, shown as dotted line [[40]] 90 in Figure 11, and that this too wanders over the area of the sheet 82 to fill it. Arrow 92 shows the general linear direction of the pattern.

**Please replace paragraph on page 26, lines 4-12 with the following amended paragraph:**

Because the alignment of the three sheets 100-104 is not precise, and because the tracks are of the order of a few thousandth of an inch wide, there is great variation between different manufactured composite multi-layered sheets as to where exactly all of the tracks are disposed, and their relative positions. Hand assembly can facilitate this degree of deliberate imprecision, but a machine can be instructed to achieve a similar effect. In this way, perhaps [[not]] even the ~~manufacture~~ ~~manufacturer~~ does not know where the trip wire tracks are with any precision reliable enough to drill into an electronic component protected by the sheet with any certainty of not hitting a wire.

**Please replace paragraph on page 26, lines 14-23 with the following amended paragraph:**

Figure 12B shows another feature. Sheet 400 comprises a Mylar sheet with a metal antenna 402 printed upon it. A signal injection [[end,]] end 404[[,]] of the antenna 402 is connectable to a signal injector device (not shown). A masking signal is input into the antenna during use of the device, the masking signal producing electromagnetic emissions that hide the electromagnetic emissions of a protected electronic component. The e.m. signals from the antenna 402 may be

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more powerful than those from the protected electronic component (e.g. PCB). They may be in the same general frequency range (or at least overlap the frequency of the e.m. signals emitted by the protected electronic component).

**Please replace paragraph on page 26, line 31-page 27, line 3 with the following amended paragraph:**

Figure 12B also shows earth plane sheet 406, similar to sheet [[36]] 36, between the sheet 400 and the protected electronic component, referenced 408 (and shown schematically). This may be to protect the component from the e.m. signals emitted by the masking layer sheet 400, and/or further hide the signals from the electronic component.

**Please replace paragraph on page 27, lines 23-32 with the following amended paragraph:**

Figures 14A to 14C ~~illustrate~~ illustrates-schematically a feature of a multi-layer Mylar sheet 130. As will be understood, the layers in the sheet 130 which rely upon electronic detection of changes in electrical or electronic parameters or characteristics need to be in communication with appropriate sensors and signal processors. The sheet 130 has a lead or tail 132 provided to do this. Because the sheet is flexible the tail can simply be bent over to contact a PCB board 134. As shown in Figure 14B, the tail 132 can be bent under the main body of the sheet 130 to contact the PCB 134 at a position 136 that is under the sheet, and that is therefore protected by the sheet.